1. Disassembly Procedures

- S1 Turn off power
- S2 Place monitor on U4919DW curve sponge jig. Disassemble VESA cover from Rear Cover



1

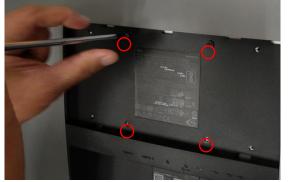


(Screw Torque:11±1Kgf)

S4

S3

Unlock 4 screws on Rear Cover



(Screw Torque:11±1Kgf)

S5 Disassemble Rear Cover from Middle Frame

(Sequence: 2 corner of top side \rightarrow the middle of top side \rightarrow left & right sides \rightarrow the 2 corner of bottom side \rightarrow the middle of bottom side)









S6 Remove USB SIDE BD FFC cable from I/F BD to take off Rear Cover



S7 Tear off AI tape from Main Shielding (See blue mark). Pull out Control BD cable from I/F BD



S8 Pull out lamp wire from PCBA



S9 Unlock 7 screws on Main Shielding

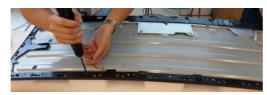


(Screw Torque:4.5±0.5kgf)

S10 Disassemble EDP cable from panel to take off Main Shielding



S11 Unlock 15 screws on Middle Frame and 7 screws on the bottom of Middle Frame. Disassemble MF from Panel

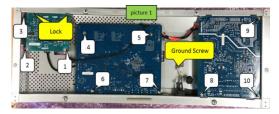


(Screw Torque:4.5±0.5kgf)

S12 Take off safety Mylar from Power BD

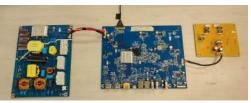


S13 Unlock 10 PCBA screws & 1 ground screw



(Screw Torque: 8.5~9.5kgf)

S14 Disassemble PCBA from Main Shielding and pull off all wires from PCBA



S15 Unlock 3 screws to disassemble "BTN PWR ABS" from middle frame



(Screw Torque: 0.95~1.05Kgf)

DELL U4919DWB

S16 Take off Control BD cable and tear off "MYLAR CTRL-BD"

Unlock 4 screws to disassemble Control

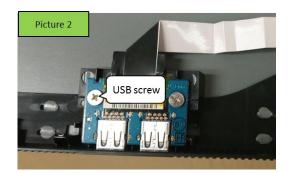
3

BD from "BTN PWR ABS"



(Screw Torque: 0.95~1.05Kgf)

S17 Unlock 2 USB screw and take off USB Side BD from Rear Cover

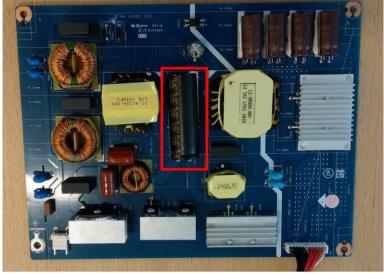


(Screw Torque: 4-5Kgf)

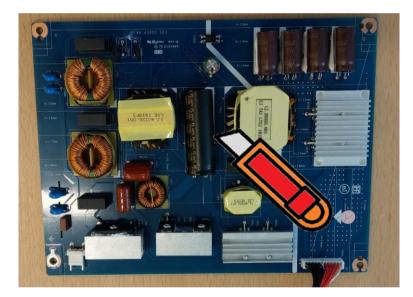
S18 Tear off tape and disassemble USB cable and USB Side BD



Remove electrolyte capacitors (red mark) from printed circuit boards



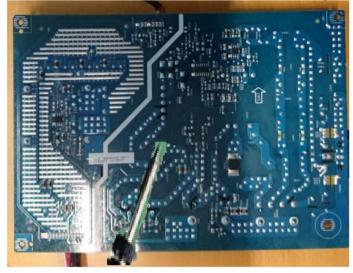
S19-1 Cut the glue between bulk cap. and PCB with a knife



S19-2 Ensure cutting path within the glue, don't touch bulk cap. or PCB

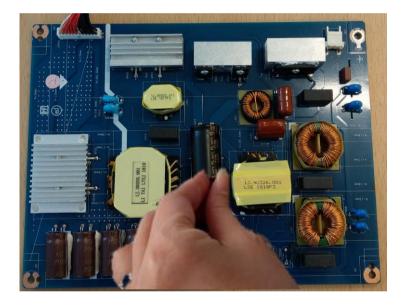


S19



S19-3 Take out bulk cap. pin solder with soldering iron and absorber

S19-4 Lift the bulk cap. up and away from the PCB



2. Product material information

The following substances, preparations, or components should be disposed of or recovered separately from other WEEE in compliance with Article 4 of EU Council Directive 75/442/EEC.

Capacitors / condensers (containing PCB/PCT)	No used
Mercury containing components	No used
Batteries	No used
Printed circuit boards (with a surface greater	Product has printed circuit boards
than 10 square cm)	(with a surface greater than 10 square
	cm)
Component contain toner, ink and liquids	No used
Plastic containing BFR	No used
Component and waste contain asbestos	No used
CRT	No used
Component contain CFC, HCFC, HFC and	No used
HC	
Gas discharge lamps	No used
LCD display > 100 cm2	Product has an LCD greater than 100
	cm2
External electric cable	Product has external cables
Component contain refractory ceramic fibers	No used
Component contain radio-active substances	No used
Electrolyte capacitors (height	Product has electrolyte capacitors
> 25mm, diameter > 25mm)	(height >25mm, diameter > 25mm)

3. Tools Required

List the type and size of the tools that would typically can be used to disassemble the product to a point where components and materials requiring selective treatment can be removed.

Tool Description:

- Screwdriver
- Penknife
- Bar scraper